

2MBI50N-120

IGBT Module

1200V / 50A 2 in one-package

■ Features

- High speed switching
- Voltage drive
- Low inductance module structure

■ Applications

- Inverter for Motor drive
- AC and DC Servo drive amplifier
- Uninterruptible power supply
- Industrial machines, such as Welding machines



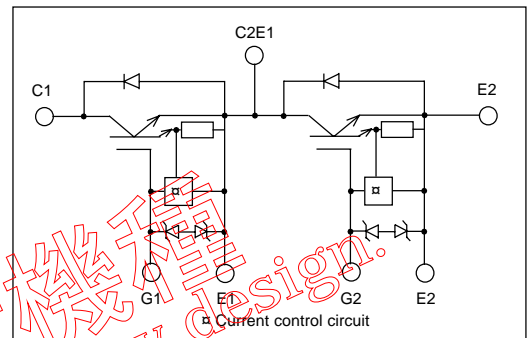
■ Maximum ratings and characteristics

● Absolute maximum ratings (at Tc=25°C unless otherwise specified)

Item	Symbol	Rating	Unit
Collector-Emitter voltage	V _{CEs}	1200	V
Gate-Emitter voltage	V _{GES}	±20	V
Collector current	Continuous	I _c	50 A
	1ms	I _c pulse	100 A
	Continuous	-I _c	50 A
	1ms	-I _c pulse	100 A
Max. power dissipation	P _c	400	W
Operating temperature	T _j	+150	°C
Storage temperature	T _{stg}	-40 to +125	°C
Isolation voltage	V _{is}	AC 2500 (1min.)	V
Screw torque	Mounting *1	3.5	N·m
	Terminals *1	3.5	N·m

*1 : Recommendable value : 2.5 to 3.5 N·m(M5)

■ Equivalent Circuit Schematic



● Electrical characteristics (at Tj=25°C unless otherwise specified)

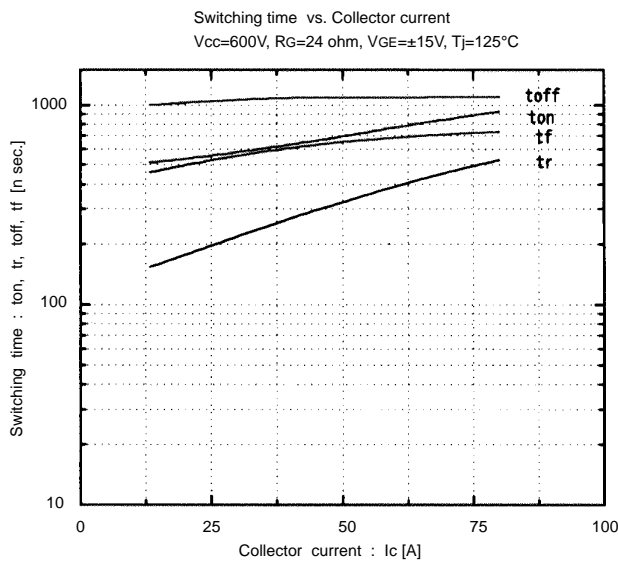
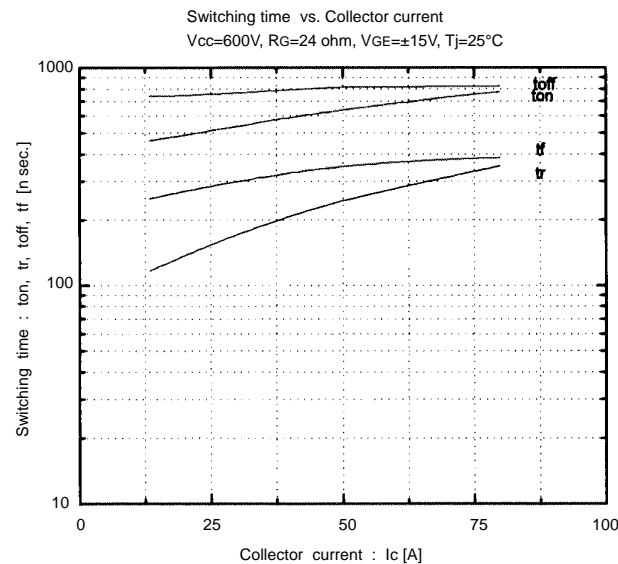
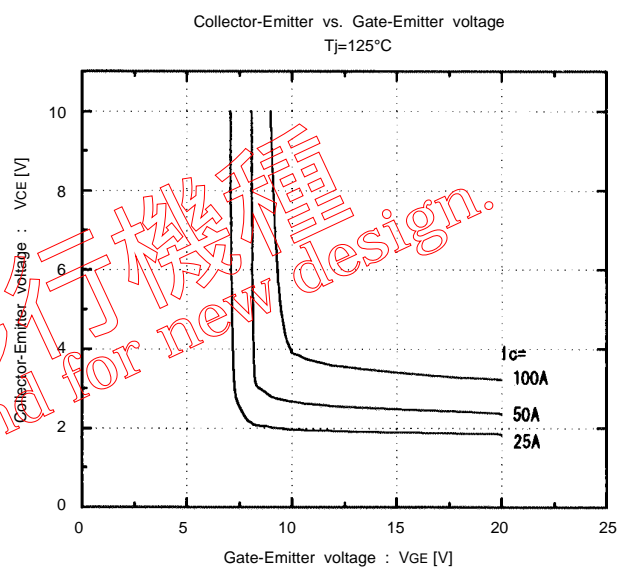
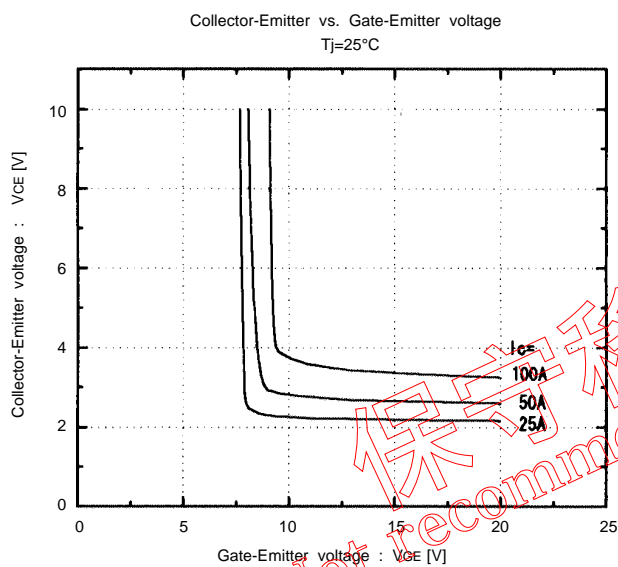
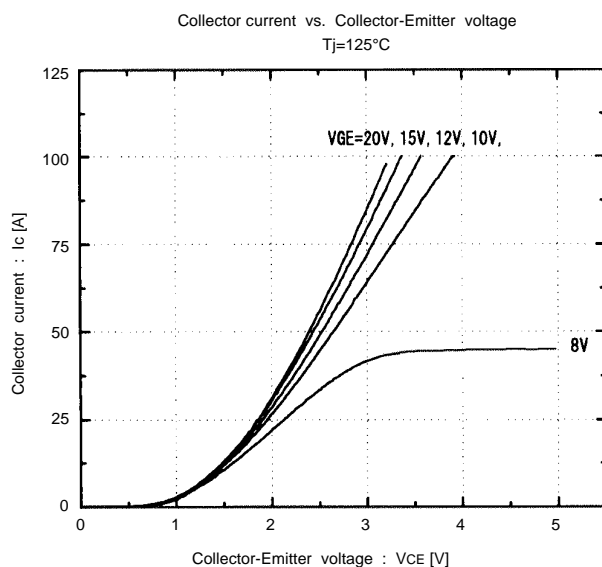
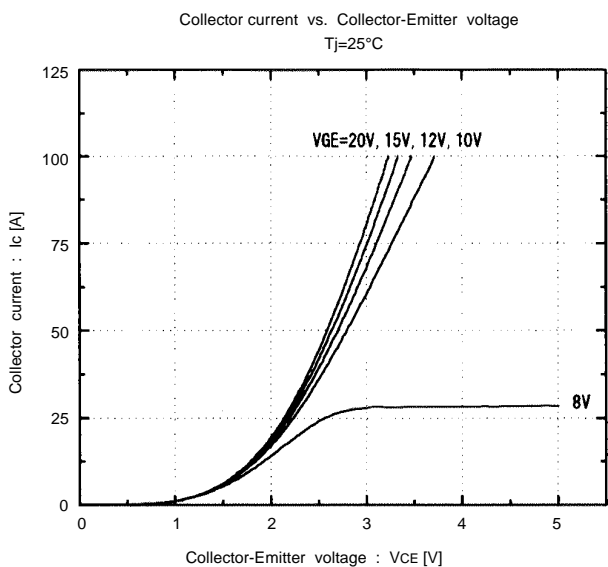
Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Zero gate voltage collector current	I _{CEs}	—	—	1.0	V _{GE} =0V, V _{CE} =1200V	mA
Gate-Emitter leakage current	I _{GES}	—	—	15	V _{CE} =0V, V _{GE} =±20V	μA
Gate-Emitter threshold voltage	V _{GE(th)}	4.5	—	7.5	V _{CE} =20V, I _c =50mA	V
Collector-Emitter saturation voltage	V _{CE(sat)}	—	—	3.3	V _{GE} =15V, I _c =50A	V
Input capacitance	C _{ies}	—	8000	—	V _{GE} =0V	pF
Output capacitance	C _{oes}	—	2900	—	V _{CE} =10V	
Reverse transfer capacitance	C _{res}	—	2580	—	f=1MHz	
Turn-on time	t _{on}	—	0.65	1.2	V _{CC} =600V	μs
	t _r	—	0.25	0.6	I _c =50A	
Turn-off time	t _{off}	—	0.85	1.5	V _{GE} =±15V	μs
	t _f	—	0.35	0.5	R _G =24 ohm	
Diode forward on voltage	V _F	—	—	3.0	I _F =50A, V _{GE} =0V	V
Reverse recovery time	t _{rr}	—	—	0.35	I _F =50A	μs

● Thermal resistance characteristics

Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Thermal resistance	R _{th(j-c)}	—	—	0.31	IGBT	°C/W
	R _{th(j-c)}	—	—	0.85	Diode	°C/W
	R _{th(c-f)*2}	—	0.05	—	the base to cooling fin	°C/W

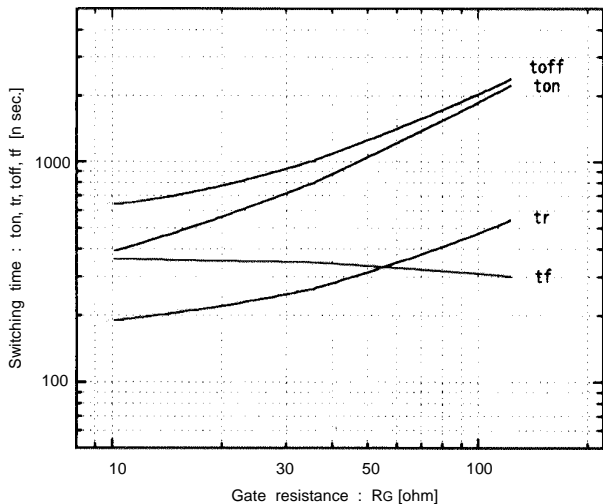
*2 : This is the value which is defined mounting on the additional cooling fin with thermal compound

Characteristics (Representative)

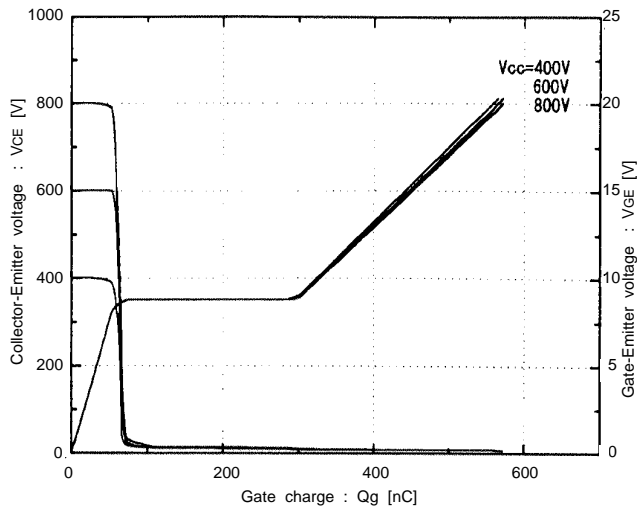


保守移行機種
 Not recommend for new design.

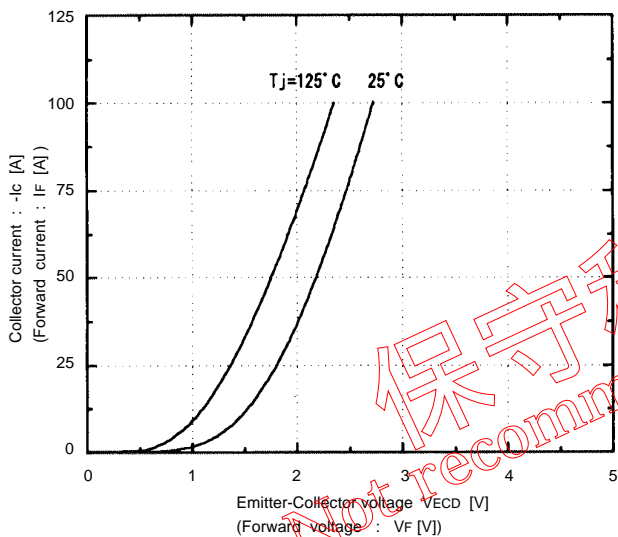
Switching time vs. R_G
 $V_{CC}=600V, I_c=50A, V_{GE}=\pm 15V, T_j=25^\circ C$



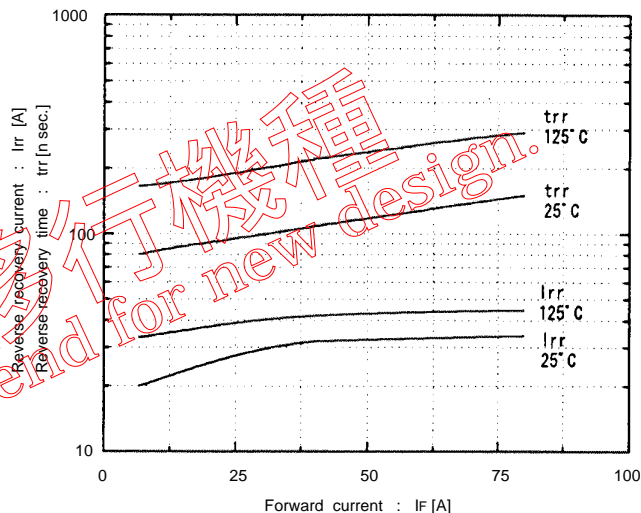
Dynamic input characteristics
 $T_j=25^\circ C$



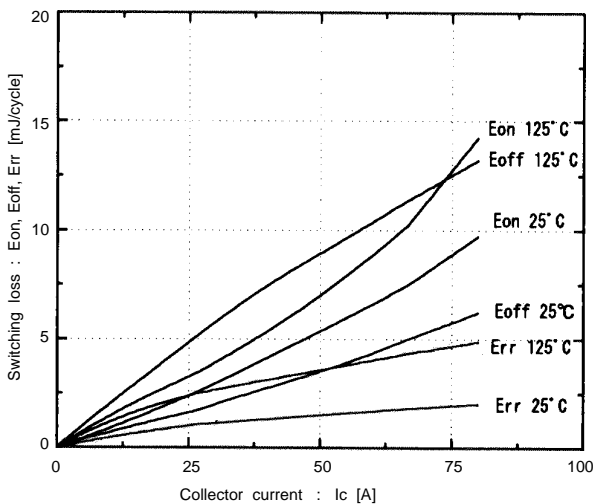
Forward current vs. Forward voltage
 $V_{GE}=0V$



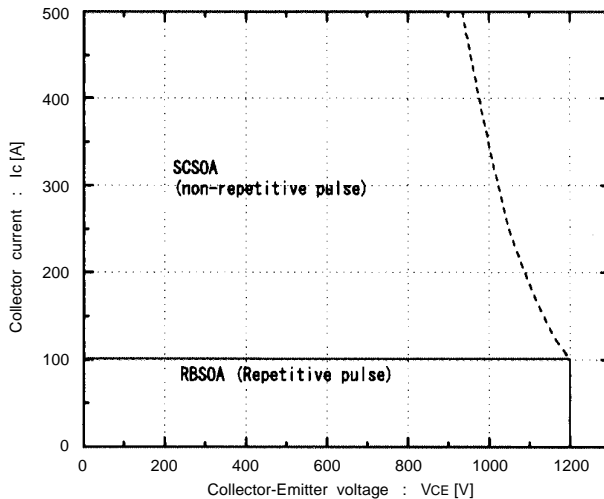
Reverse recovery characteristics
 t_{rr}, I_{rr} , vs. I_F

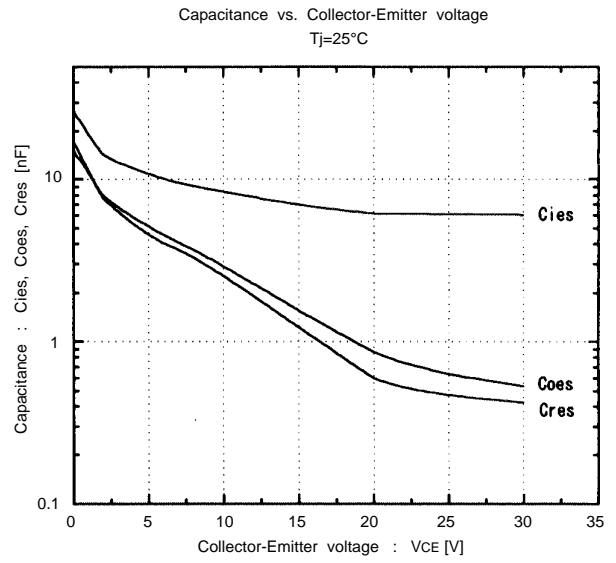
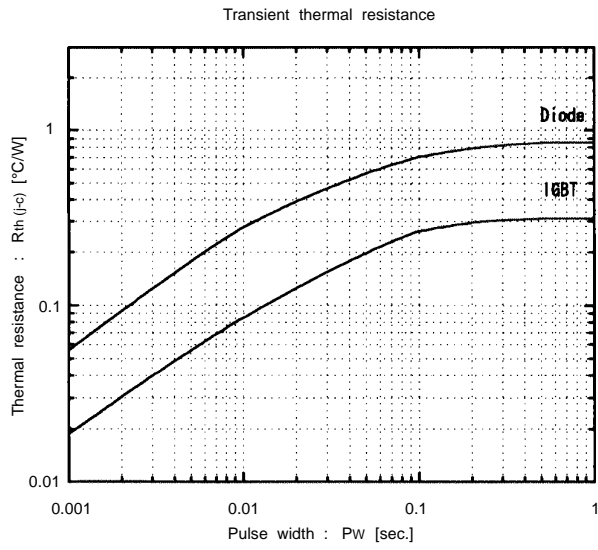


Switching loss vs. Collector current
 $V_{CC}=600V, R_G=24\text{ ohm}, V_{GE}=\pm 15V$



Reversed biased safe operating area
 $+V_{GE}=15V, -V_{GE} \leq 15V, T_j \leq 125^\circ C, R_G \geq 24\text{ ohm}$





■ Outline Drawings, mm

